

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



#### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	3 A			
V <sub>RRM</sub>	60 V			
I <sub>FSM</sub>	80 A			
$V_F$ at $I_F$ = 1.5 A ( $T_J$ = 125 °C)	0.42 V			
T <sub>J</sub> max.	175 °C			
Package	DFN3820A			
Circuit configuration	Single			

#### **FEATURES**

• Low profile package - typical height of 0.88 mm



- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

ROHS COMPLIANT HALOGEN FREE

- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Compatible to SMP (DO-220AA) package case outline
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

#### TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

#### **MECHANICAL DATA**

Case: DFN3820A

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

D--- D/NII MAO

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V3NM63	UNIT	
Device marking code		3MF		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	60	V	
Maximum average forward rectified current (fig. 1)	I <sub>F(AV)</sub> <sup>(1)</sup>	3	А	
Maximum average forward rectified current (fig. 1)	I <sub>F(AV)</sub> (2)	2.2	A	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	80	А	
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +175	°C	
Storage temperature range	T <sub>STG</sub>	-55 to +175	°C	

#### **Notes**

- (1) Mounted on 10 mm x 10 mm copper pad area PCB
- (2) Free air, mounted on FR4 PCB, 2 oz., standard footprint
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$



<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 1.5 A	T <sub>J</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.51	-	V
	I <sub>F</sub> = 3.0 A			0.58	0.63	
	I <sub>F</sub> = 1.5 A	- T <sub>J</sub> = 125 °C		0.42	-	
	I <sub>F</sub> = 3.0 A			0.50	0.56	
Reverse current	V - 60 V	$V_R = 60 \text{ V}$ $T_J = 25 \text{ °C}$ $T_J = 125 \text{ °C}$	I <sub>R</sub> <sup>(2)</sup>	-	0.01	- mA
	v <sub>R</sub> = 60 v			0.4	1.5	
Typical junction capacitance	4.0 V, 1 MF	4.0 V, 1 MHz		560	-	pF

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)				
PARAMETER SYMBOL TYP. MAX. U				
Thermal resistance	R <sub>0</sub> JA (1)(2)	135	169	°C/W
mermai resistance	R <sub>0JM</sub> (3)	5	6.3	

#### Notes

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V3NM63-M3/H	0.023	Н	3500	7" diameter plastic tape and reel	
V3NM63-M3/I	0.023	I	14 000	13" diameter plastic tape and reel	
V3NM63HM3/H (1)	0.023	Н	3500	7" diameter plastic tape and reel	
V3NM63HM3/I (1)	0.023	I	14 000	13" diameter plastic tape and reel	

#### Note

(1) AEC-Q101 qualified

## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise noted)

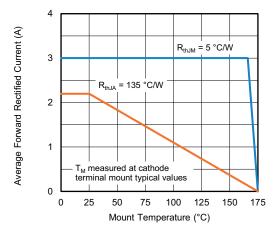


Fig. 1 - Maximum Forward Current Derating Curve

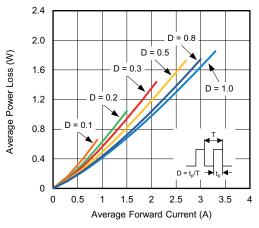


Fig. 2 - Forward Power Loss Characteristics

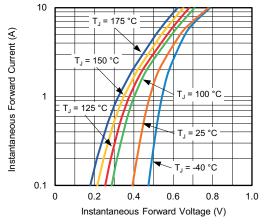


Fig. 3 - Typical Instantaneous Forward Characteristics

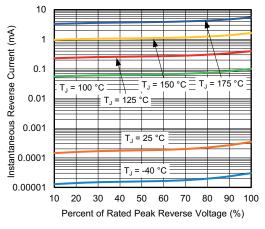


Fig. 4 - Typical Reverse Characteristics

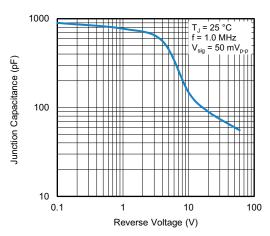


Fig. 5 - Typical Junction Capacitance

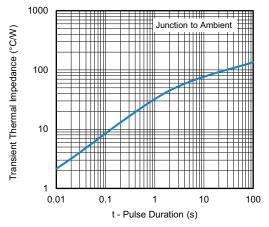
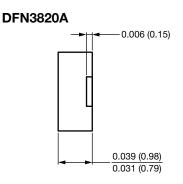


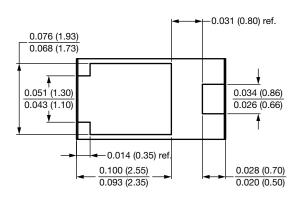
Fig. 6 - Typical Transient Thermal Impedance

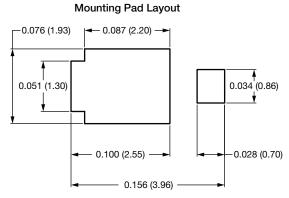


### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

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